

N-channel 80 V, 0.008 Ω typ., 100 A, STripFET™ F6 Power MOSFET in a TO-220 package

Datasheet - production data

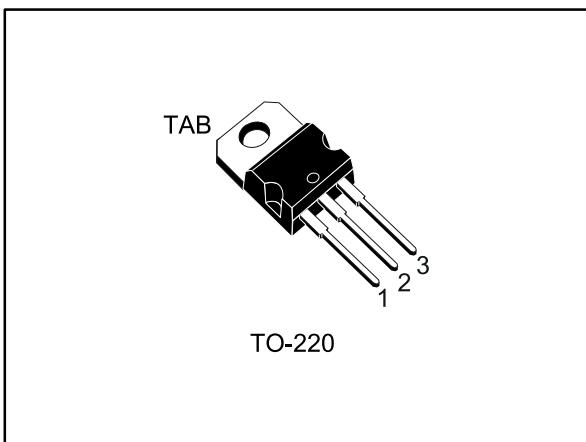
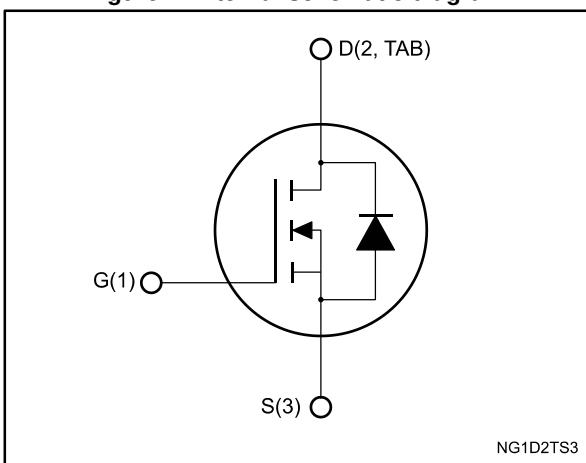


Figure 1: Internal schematic diagram



Features

| Order code | V _{DS} | R _{D(on)max.} | I _D | P _{TOT} |
|------------|-----------------|------------------------|----------------|------------------|
| STP100N8F6 | 80 V | 0.009 Ω | 100 A | 176 W |

- Very low on-resistance
- Very low gate charge
- High avalanche ruggedness
- Low gate drive power loss

Applications

- Switching applications

Description

This device is an N-channel Power MOSFET developed using the STripFET™ F6 technology with a new trench gate structure. The resulting Power MOSFET exhibits very low R_{D(on)} in all packages.

Table 1: Device summary

| Order code | Marking | Package | Packing |
|------------|---------|---------|---------|
| STP100N8F6 | 100N8F6 | TO-220 | Tube |

Contents

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1 Electrical ratings

Table 2: Absolute maximum ratings

| Symbol | Parameter | Value | Unit |
|----------------|---|------------|------------------|
| V_{DS} | Drain-source voltage | 80 | V |
| V_{GS} | Gate-source voltage | ± 20 | V |
| I_D | Drain current (continuous) at $T_C = 25^\circ\text{C}$ | 100 | A |
| I_D | Drain current (continuous) at $T_C = 100^\circ\text{C}$ | 70 | A |
| $I_{DM}^{(1)}$ | Drain current (pulsed) | 400 | A |
| P_{TOT} | Total dissipation at $T_C = 25^\circ\text{C}$ | 176 | W |
| $E_{AS}^{(2)}$ | Single pulse avalanche energy | 170 | mJ |
| T_J | Operating junction temperature range | -55 to 175 | $^\circ\text{C}$ |
| T_{stg} | Storage temperature range | | $^\circ\text{C}$ |

Notes:

(1) Pulse width is limited by safe operating area.

(2) Starting $T_j = 25^\circ\text{C}$, $I_d = 25\text{ A}$, $V_{dd} = 40\text{ V}$.

Table 3: Thermal data

| Symbol | Parameter | Value | Unit |
|----------------|--|-------|---------------------------|
| $R_{thj-case}$ | Thermal resistance junction-case max. | 0.85 | $^\circ\text{C}/\text{W}$ |
| $R_{thj-amb}$ | Thermal resistance junction-ambient max. | 62.5 | $^\circ\text{C}/\text{W}$ |

2 Electrical characteristics

($T_C = 25^\circ\text{C}$ unless otherwise specified)

Table 4: On /off-states

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-----------------------------|-----------------------------------|--|------|-------|-------|---------------|
| $V_{(\text{BR})\text{DSS}}$ | Drain-source breakdown voltage | $V_{GS} = 0$, $I_D = 250 \mu\text{A}$ | 80 | | | V |
| $I_{\text{DS}}\text{s}$ | Zero-gate voltage drain current | $V_{GS} = 0$, $V_{DS} = 80 \text{ V}$ | | | 1 | μA |
| | | $V_{GS} = 0$, $V_{DS} = 80 \text{ V}$, $T_C = 125^\circ\text{C}$ | | | 100 | μA |
| I_{GSS} | Gate-body leakage current | $V_{DS} = 0$, $V_{GS} = \pm 20 \text{ V}$ | | | 100 | nA |
| $V_{GS(\text{th})}$ | Gate threshold voltage | $V_{DS} = V_{GS}$, $I_D = 250 \mu\text{A}$ | 2 | | 4 | V |
| $R_{DS(\text{on})}$ | Static drain-source on-resistance | $V_{GS} = 10 \text{ V}$, $I_D = 50 \text{ A}$ | | 0.008 | 0.009 | Ω |

Table 5: Dynamic

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-----------|------------------------------|--|------|------|------|------|
| C_{iss} | Input capacitance | $V_{GS} = 0$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$ | - | 5955 | - | pF |
| C_{oss} | Output capacitance | | - | 244 | - | pF |
| C_{rss} | Reverse transfer capacitance | | - | 160 | - | pF |
| Q_g | Total gate charge | $V_{DD} = 40 \text{ V}$, $I_D = 100 \text{ A}$, | - | 100 | - | nC |
| Q_{gs} | Gate-source charge | $V_{GS} = 10 \text{ V}$ (see <i>Figure 14: "Test circuit for gate charge behavior"</i>) | - | 30 | - | nC |
| Q_{gd} | Gate-drain charge | | - | 25 | - | nC |

Table 6: Switching times

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|--------------|---------------------|---|------|------|------|------|
| $t_{d(on)}$ | Turn-on delay time | $V_{DD} = 40 \text{ V}$, $I_D = 50 \text{ A}$, $R_G = 4.7 \Omega$, $V_{GS} = 10 \text{ V}$ (see <i>Figure 13: "Test circuit for resistive load switching times"</i> and <i>Figure 18: "Switching time waveform"</i>) | - | 33 | - | ns |
| t_r | Rise time | | - | 46 | - | ns |
| $t_{d(off)}$ | Turn-off delay time | | - | 103 | - | ns |
| t_f | Fall time | | - | 21 | - | ns |

Table 7: Source-drain diode

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|----------------|--------------------------|--|------|------|------|------|
| $V_{SD}^{(1)}$ | Forward on voltage | $V_{GS} = 0$, $I_{SD} = 100$ A | - | | 1.2 | V |
| t_{rr} | Reverse recovery time | $I_{SD} = 100$ A, $di/dt = 100$ A/ μ s $V_{DD} = 64$ V (see <i>Figure 15: "Test circuit for inductive load switching and diode recovery times"</i>) | - | 38 | | ns |
| Q_{rr} | Reverse recovery charge | | - | 63 | | nC |
| I_{RRM} | Reverse recovery current | | - | 3.3 | | A |

Notes:(1) Pulsed: pulse duration = 300 μ s, duty cycle 1.5%.

2.1 Electrical characteristics (curves)

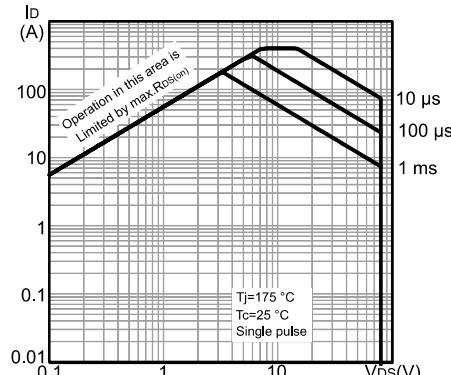
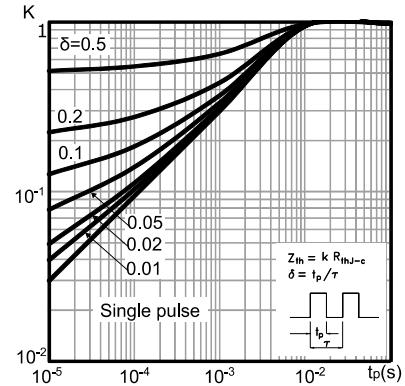
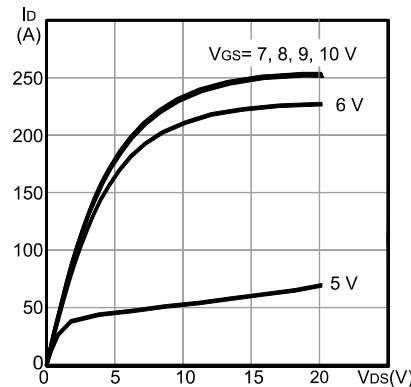
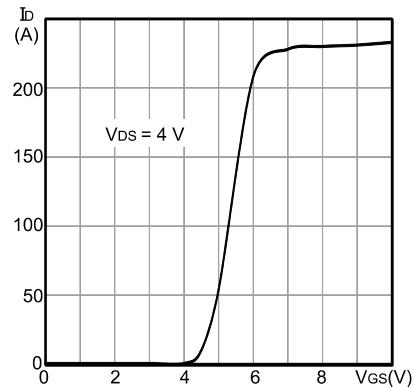
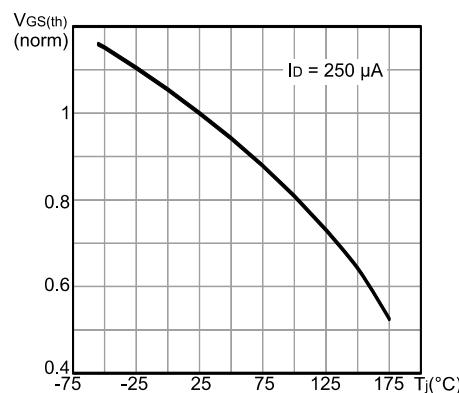
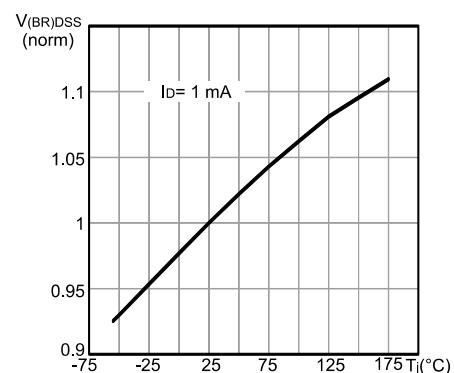
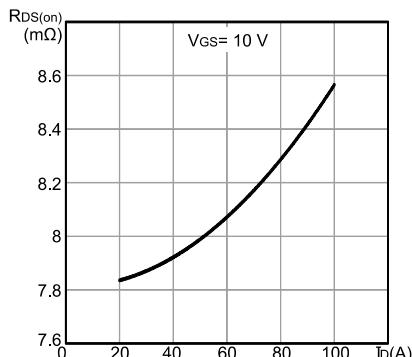
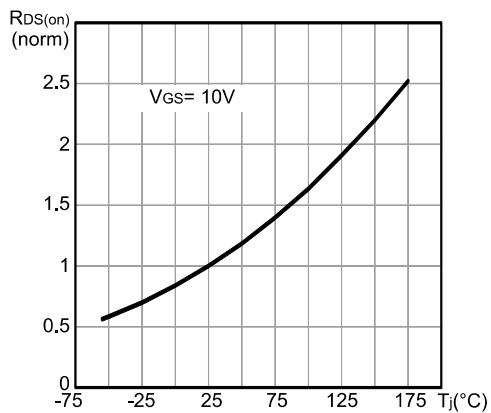
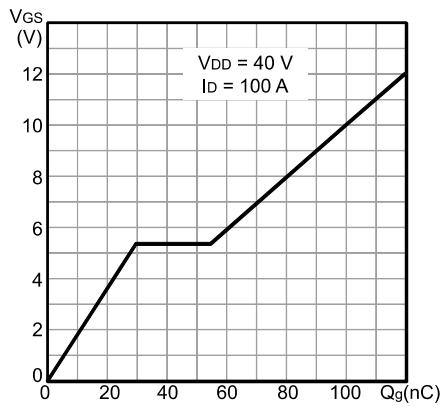
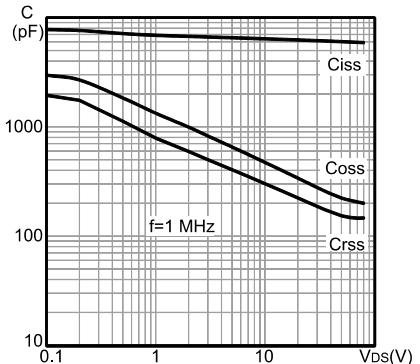
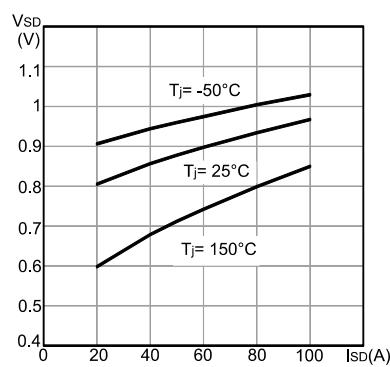
Figure 2: Safe operating area**Figure 3: Thermal impedance****Figure 4: Output characteristics****Figure 5: Transfer characteristics****Figure 6: Normalized gate threshold voltage vs. temperature****Figure 7: Normalized V(BR)DSS vs. temperature**

Figure 8: Static drain-source on-resistance**Figure 9: Normalized on-resistance vs. temperature****Figure 10: Gate charge vs. gate-source voltage****Figure 11: Capacitance variations****Figure 12: Source-drain diode forward characteristics**

3 Test circuits

Figure 13: Test circuit for resistive load switching times

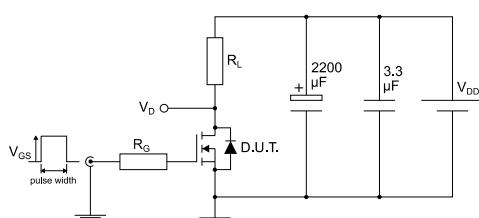


Figure 14: Test circuit for gate charge behavior

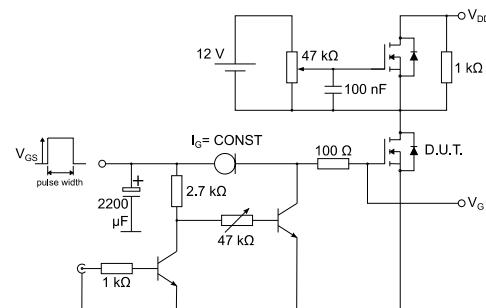


Figure 15: Test circuit for inductive load switching and diode recovery times

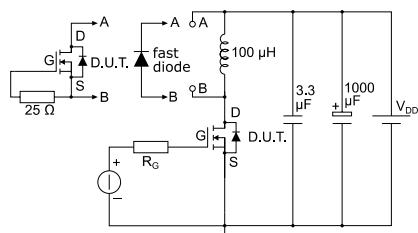


Figure 16: Unclamped inductive load test circuit

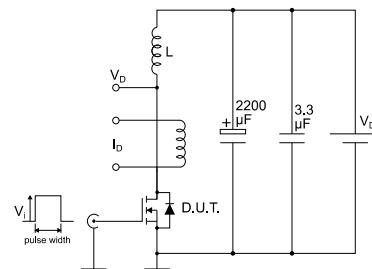


Figure 17: Unclamped inductive waveform

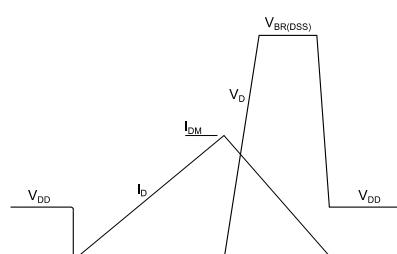
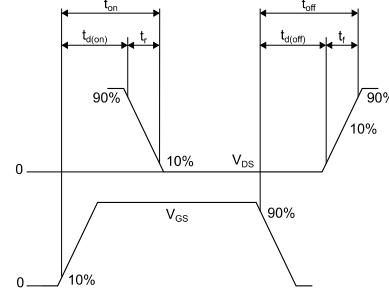


Figure 18: Switching time waveform



4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com.
ECOPACK® is an ST trademark.

4.1 TO-220 type A package information

Figure 19: TO-220 type A package outline

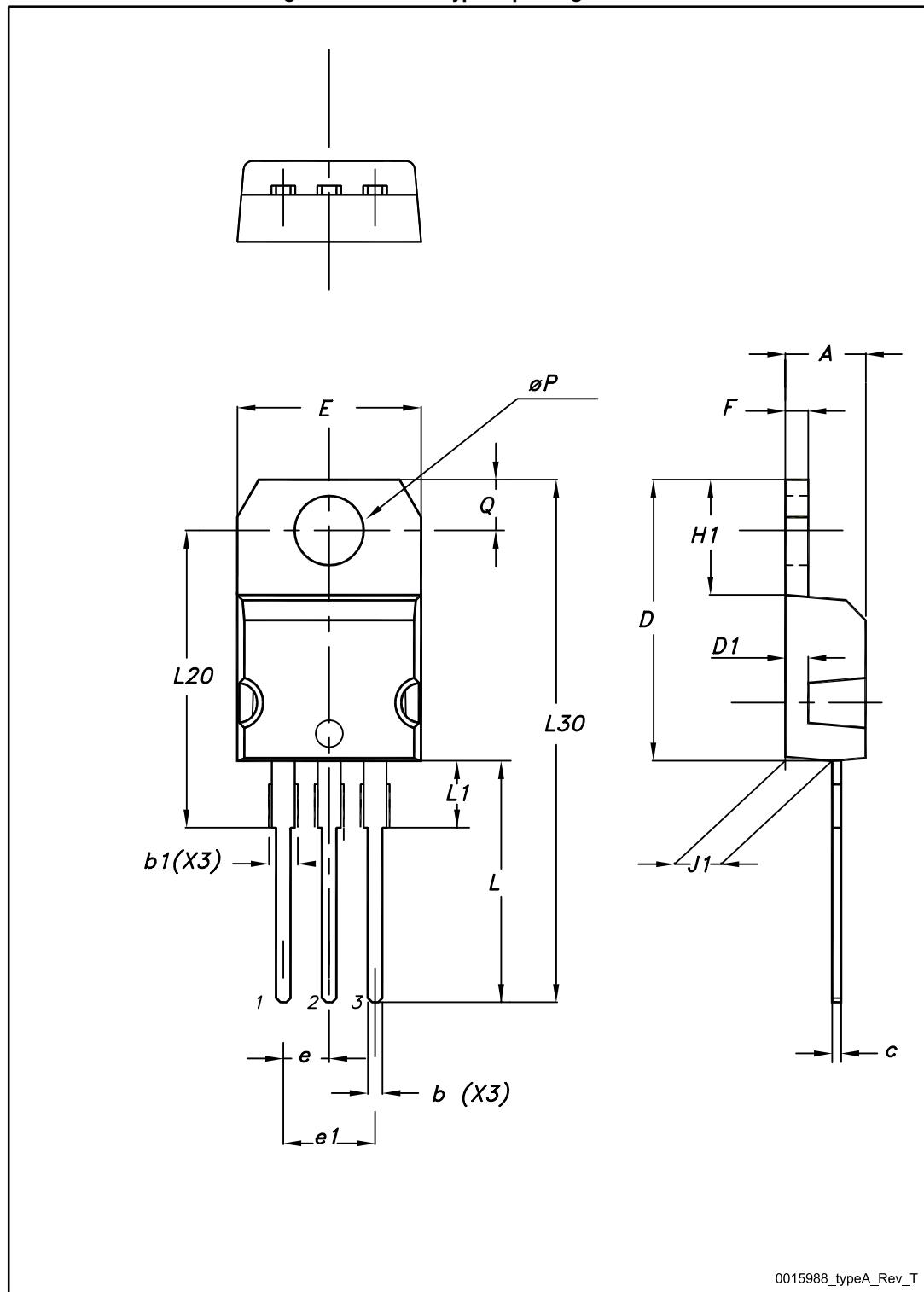


Table 8: TO-220 type A mechanical data

| Dim. | mm | | |
|------|-------|-------|-------|
| | Min. | Typ. | Max. |
| A | 4.40 | | 4.60 |
| b | 0.61 | | 0.88 |
| b1 | 1.14 | | 1.70 |
| c | 0.48 | | 0.70 |
| D | 15.25 | | 15.75 |
| D1 | | 1.27 | |
| E | 10 | | 10.40 |
| e | 2.40 | | 2.70 |
| e1 | 4.95 | | 5.15 |
| F | 1.23 | | 1.32 |
| H1 | 6.20 | | 6.60 |
| J1 | 2.40 | | 2.72 |
| L | 13 | | 14 |
| L1 | 3.50 | | 3.93 |
| L20 | | 16.40 | |
| L30 | | 28.90 | |
| øP | 3.75 | | 3.85 |
| Q | 2.65 | | 2.95 |

4.2 TO-220 type H package information

Figure 20: TO-220 type H package outline

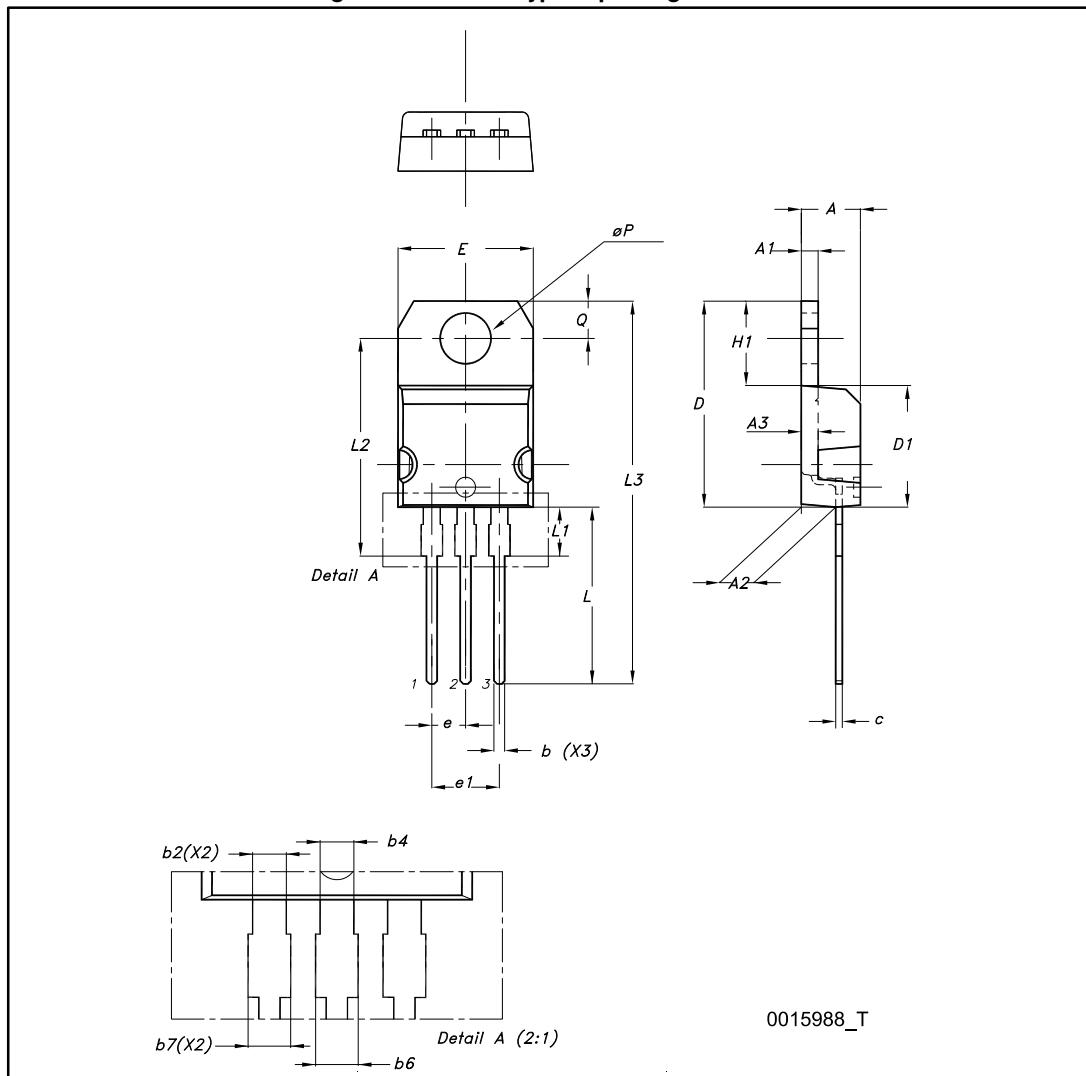


Table 9: TO-220 type H package mechanical data

| Dim. | mm | | |
|------|-------|-------|-------|
| | Min. | Typ. | Max. |
| A | 4.40 | 4.45 | 4.50 |
| A1 | 1.22 | | 1.32 |
| A2 | 2.49 | 2.59 | 2.69 |
| A3 | 1.17 | 1.27 | 1.37 |
| b | 0.78 | | 0.87 |
| b2 | 1.25 | | 1.34 |
| b4 | 1.20 | | 1.29 |
| b6 | | | 1.50 |
| b7 | | | 1.45 |
| c | 0.49 | | 0.56 |
| D | 15.40 | 15.50 | 15.60 |
| D1 | 9.05 | 9.15 | 9.25 |
| E | 10.08 | 10.18 | 10.28 |
| e | 2.44 | 2.54 | 2.64 |
| e1 | 4.98 | 5.08 | 5.18 |
| H1 | 6.25 | 6.35 | 6.45 |
| L | 13.20 | 13.40 | 13.60 |
| L1 | 3.50 | 3.70 | 3.90 |
| L2 | 16.30 | 16.40 | 16.50 |
| L3 | 28.70 | 28.90 | 29.10 |
| ØP | 3.75 | 3.80 | 3.85 |
| Q | 2.70 | 2.80 | 2.90 |

5 Revision history

Table 10: Document revision history

| Date | Revision | Changes |
|-------------|----------|---|
| 02-Sep-2014 | 1 | Initial release. |
| 02-Dec-2014 | 2 | Document status promoted from preliminary to production data. Added the section of electrical characteristics (curves). Minor text changes. |
| 08-Feb-2016 | 3 | Added Section 4.2: "TO-220 type H package information" . |

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